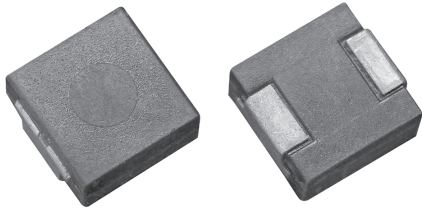


Molded, Low Profile, High Current Inductor



Manufactured under one or more of the following:
US Patents; 6,198,375 / 6,204,744 / 6,449,829 / 6,460,244.
 Several foreign patents, and other patents pending.

STANDARD ELECTRICAL SPECIFICATIONS

Lo INDUCTANCE $\mu\text{H} \pm 20\%$ @100KHz, .25V, 0A	DCR $\text{m}\Omega$		HEAT RATING CURRENT DC AMPS ³ TYPICAL	SATURATION CURRENT DC AMPS ⁴ TYPICAL
	TYPICAL 25°C	MAX 25°C		
0.10	1.5	1.7	32.5	60
0.15	1.9	2.5	26	52
0.20	2.4	3.0	24	41
0.22	2.5	2.8	23	40
0.33	3.5	3.9	20	30
0.47	4	4.2	17.5	26
0.68	5	5.5	15.5	25
0.82	6.7	8	13	24
1.0	9	10	11	22
1.5	14	15	9	18
2.2	18	20	8	14
3.3	28	30	6	13.5
4.7	37	40	5.5	10
6.8	54	60	4.5	8
8.2	64	68	4	7.5
10	102	105	3	7.0

NOTES:

- All test data is referenced to 25°C ambient.
- Operating Temperature Range - 55°C to + 125°C
- DC current (A) that will cause an approximate ΔT of 40°C.
- DC current (A) that will cause L_o to drop approximately 20%
- The part temperature (ambient + temp rise) should not exceed 125°C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

DESCRIPTION

IHLM-2525CZ-01	1.0 μH	$\pm 20\%$
MODEL	INDUCTANCE VALUE	INDUCTANCE TOLERANCE

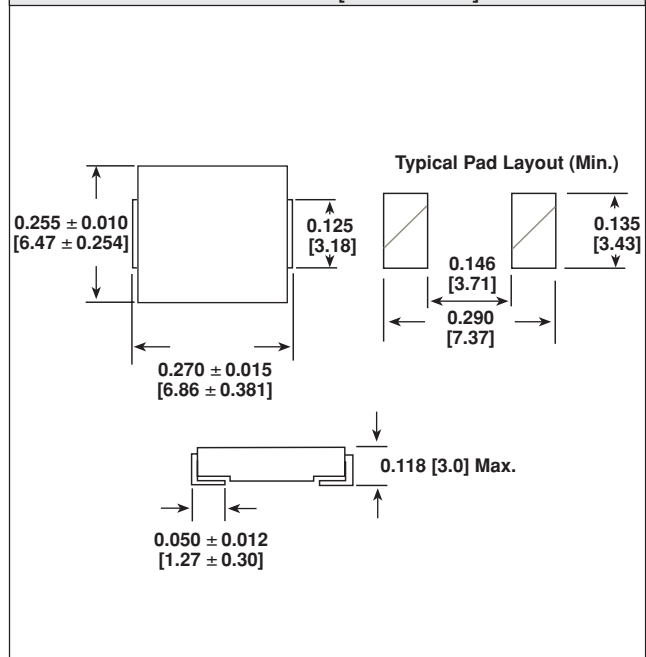
FEATURES

- Lowest molded height (3.0mm) in this package footprint.
- Shielded construction.
- Frequency range up to 5.0MHz.
- Lowest DCR/ μH , in this package size.
- Handles high transient current spikes without saturation.
- Ultra low buzz noise, due to composite construction.
- 100% lead (Pb)-free.
- Encapsulated body offers improved environmental protection and moisture resistance
- Higher dielectric withstanding voltage vs IHLP
- Flame retardant encapsulant (UL 94V-0)
- Corrosion resistant package

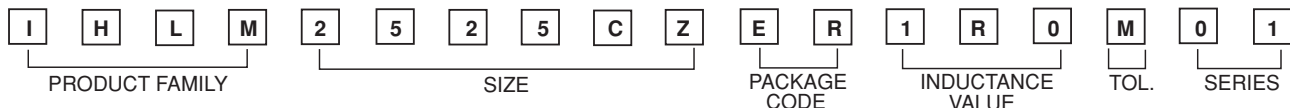
APPLICATIONS

- PDA/Notebook/Desktop/Server applications.
- High current POL converters.
- Low profile, high current power supplies.
- Battery powered devices.
- DC/DC converters in distributed power systems.
- DC/DC converter for Field Programmable Gate Array (FPGA).
- Harsh environments including moisture, chemicals and salt spray.

DIMENSIONS in inches [millimeters]



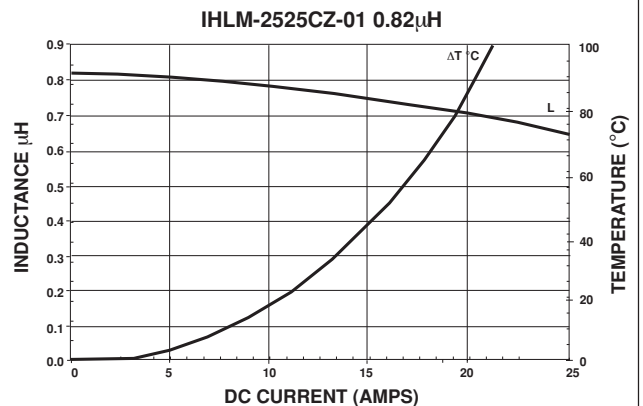
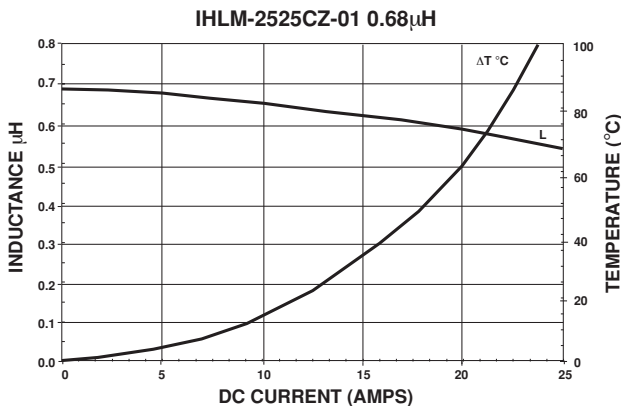
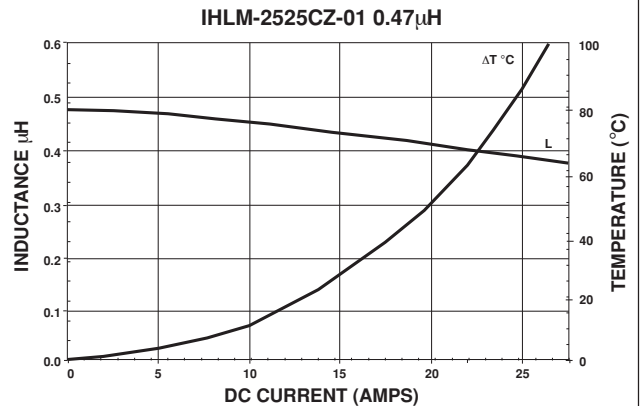
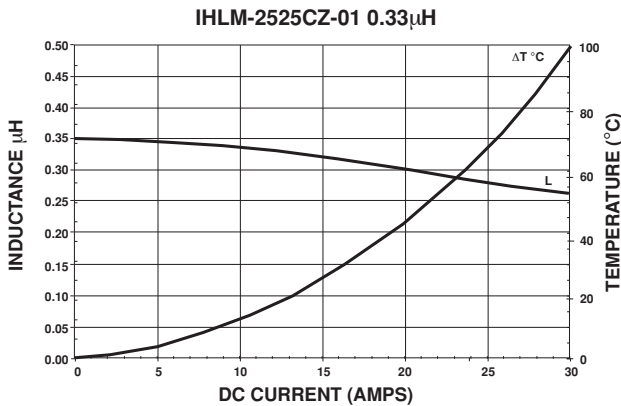
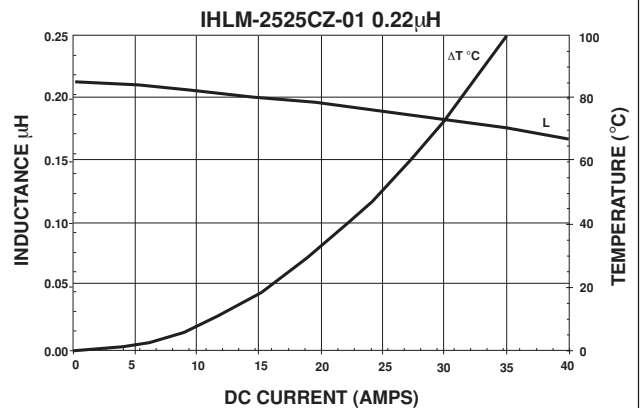
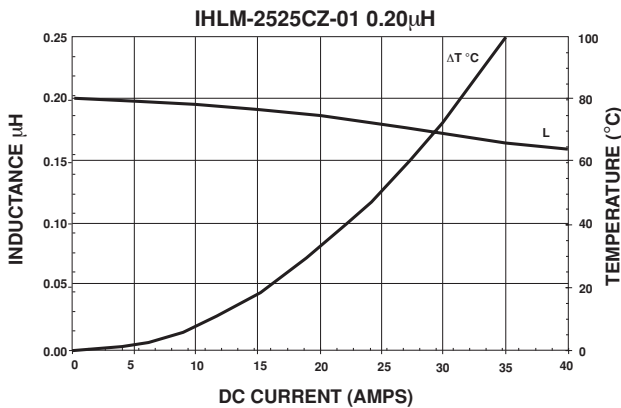
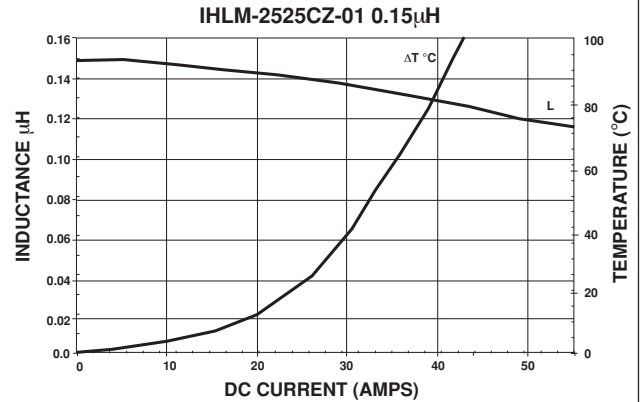
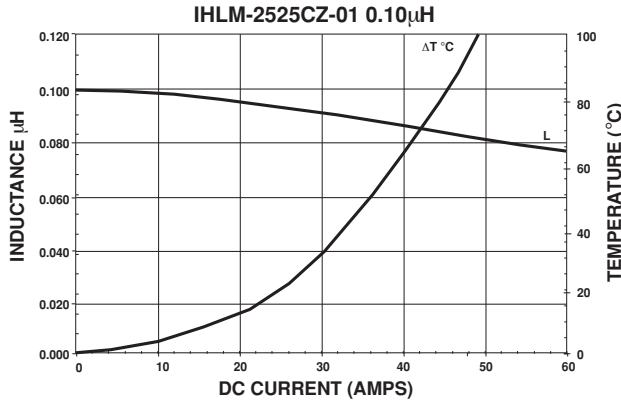
SAP PART NUMBERING GUIDELINES (INTERNAL)



See the end of this data book for conversion tables



PERFORMANCE GRAPHS



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